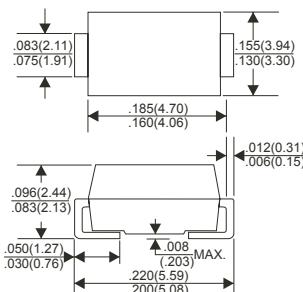


RoHS Compliant Product
A suffix of "-C" specifies halogen & lead-free

FEATURES

- High Current Capability
- Extremely Low Thermal Resistance
- For Surface Mount Application
- Higher Temp Soldering : 250°C for 10 Seconds at Terminals
- Low Reverse Current

DO-214AA (SMB)



Dimensions in inches and (millimeters)

MECHANICAL DATA

- Case: Molded Plastic
- Epoxy: UL 94V-0 Rate Flame Retardant
- Lead: Axial Leads, Solderable per MIL-STD-202 method 208 Guaranteed
- Polarity: Color Band Denotes Cathode End
- Mounting Position: Any

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwise specified.

Single phase half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

TYPE NUMBER	SYMBOL	SM3200B	UNITS
Peak Repetitive Peak reverse voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	200	V
Maximum DC Blocking Voltage	V_R		
Average Forward Current @ $T_J=25^\circ\text{C}$	$I_{F(AV)}$	3	A
Peak Forward Current @ 8.3 ms Half Sine	I_{FSM}	90	A
Maximum Instantaneous Forward Voltage $V_F @ I_{FM} = 3.0 \text{ A}, T_A = 25^\circ\text{C}$ $V_F @ I_{FM} = 3.0 \text{ A}, T_A = 75^\circ\text{C}$ $V_F @ I_{FM} = 3.0 \text{ A}, T_A = 125^\circ\text{C}$	V_F	0.85 0.75 0.68	V
Maximum DC Reverse Current At Rated DC Blocking Voltage @ $T_J = 25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_J = 100^\circ\text{C}$	I_R	5 80	μA
Typical Junction Capacitance	C_J	60	pF
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	50	$^\circ\text{C}/\text{W}$
Voltage Rate of Change (Rated V_R)	dv/dt	1000	$\text{V}/\mu\text{s}$
Operating Temperature Range	T_J	-50 ~ + 125	$^\circ\text{C}$
Storage temperature	T_{STG}	-65 ~ + 150	$^\circ\text{C}$

NOTES:

1. Measured at 1MHz and applied reverse voltage of 5.0 V D.C.
2. Thermal Resistance Junction to Ambient.

RATINGS AND CHARACTERISTIC CURVES

